Product data sheet

1. General description

Low-leakage diode in an ultra small DFN1006BD-2 (SOD882BD) leadless Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

2. Features and benefits

- Switching time: max. t_{rr} = 3 μs
- Low leakage current: max. I_R = 5 nA
- Repetitive peak reverse voltage: V_{RRM} ≤ 85 V
- Low capacitance typical: C_d = 2 pF
- Ultra small and leadless SMD plastic package
- · Suitable for Automatic Optical Inspection (AOI) of solder joint

3. Applications

- · Low-leakage current applications
- · General-purpose switching

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _F	forward current	T _{amb} = 25 °C	[1]	-	-	325	mA
I _R	reverse current	V _R = 75 V; pulsed; T _{amb} = 25 °C		-	-	5	nA
V_R	reverse voltage	T _{amb} = 25 °C		-	-	75	V
V _F	forward voltage	I_F = 150 mA; $t_p \le 300$ μs; $δ \le 0.02$; pulsed; T_{amb} = 25 °C		-	-	1.25	V
V _{RRM}	repetitive peak reverse voltage			-	-	85	V
t _{rr}	reverse recovery time	$I_F = 10 \text{ mA}; I_R = 10 \text{ mA}; I_{R(meas)} = 1 \text{ mA};$ $R_L = 100 \Omega; T_{amb} = 25 \text{ °C}$		-	-	3	μs

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated and standard footprint.



Low-leakage diode

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	А	anode		к А
			Transparent top view	aaa-028035
			DFN1006BD-2 (SOD882BD)	

6. Ordering information

Table 3. Ordering information

Type number Package						
	Name	Description	Version			
BAS116LS		Leadless ultra small plastic package with side-wettable flanks (SWF); 2 terminals; 0.65 mm pitch; 1 mm x 0.6 mm x 0.47 mm body	SOD882BD			

7. Marking

Table 4. Marking codes

Type number	Marking code
BAS116LS	9C

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T _{amb} = 25 °C		-	75	V
V_{RRM}	repetitive peak reverse voltage			-	85	V
I _F	forward current	T _{amb} = 25 °C	[1]	-	325	mA
I _{FRM}	repetitive peak forward current	$t_p \le 0.5 \text{ ms}; \delta \le 0.25; T_{amb} = 25 \text{ °C}$		-	700	mA
I _{FSM}	non-repetitive peak	t _p = 100 μs; square wave		-	4	А
	forward current	t _p = 1 ms; square wave		-	1.5	А
		t _p = 1 s; square wave		-	0.5	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	345	mW
			[2]	-	645	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated and standard footprint.

^[2] Device mounted on an FR4 PCB, 70 µm single-sided copper, tin-plated, mounting pad for cathode 1 cm².

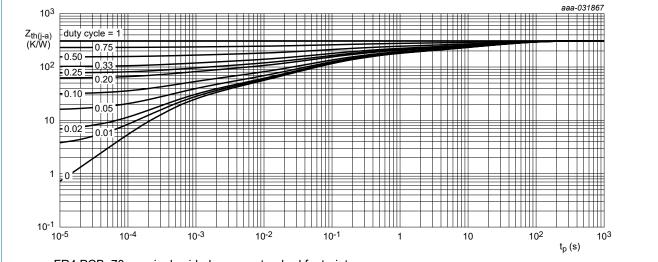
Low-leakage diode

9. Thermal characteristics

Table 6. Thermal characteristics

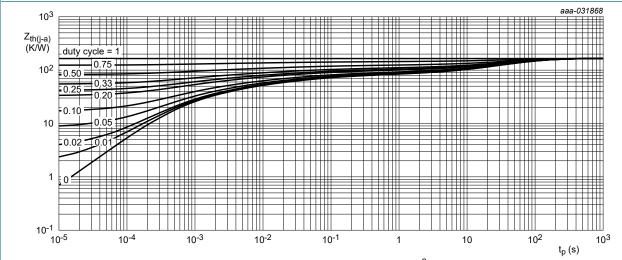
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
""(J-"a)	thermal resistance from	in free air	[1]	-	-	360	K/W
	junction to ambient		[2]	-	-	195	K/W

- [1] Device mounted on an FR4 PCB, 70 µm single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, 70 µm single-sided copper, tin-plated, mounting pad for cathode 1 cm².



FR4 PCB, 70 µm single sided copper standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 70 µm single sided copper, mounting pad for cathode 1 cm²

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

Low-leakage diode

10. Characteristics

Table 7. Characteristics

Parameter	Conditions		Min	Тур	Max	Unit
forward voltage	I_F = 1 mA; $t_p \le 300$ μs; $\delta \le 0.02$; pulsed; T_{amb} = 25 °C		-	-	0.9	V
	I_F = 10 mA; $t_p \le 300$ μs; $δ \le 0.02$; pulsed; T_{amb} = 25 °C		-	-	1	V
	I_F = 50 mA; $t_p \le 300$ μs; $δ \le 0.02$; pulsed; T_{amb} = 25 °C		-	-	1.1	V
	I_F = 150 mA; $t_p \le 300$ μs; $δ \le 0.02$; pulsed; T_{amb} = 25 °C		-	-	1.25	V
reverse current	V _R = 75 V; pulsed; T _{amb} = 25 °C		-	-	5	nA
	V _R = 75 V; pulsed; T _{amb} = 150 °C		-	-	80	nA
diode capacitance	V _R = 0 V; f = 1 MHz; T _{amb} = 25 °C		-	2	-	pF
reverse recovery time	I_F = 10 mA; I_R = 10 mA; $I_{R(meas)}$ = 1 mA; I_{L} = 100 Ω; I_{L} = 25 °C		-	-	3	μs
	forward voltage reverse current diode capacitance	$ \begin{array}{l} \text{forward voltage} & \text{I}_{\text{F}} = 1 \text{ mA; } t_{\text{p}} \leq 300 \mu \text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{\text{amb}} = 25 ^{\circ}\text{C} \\ \\ \text{I}_{\text{F}} = 10 \text{ mA; } t_{\text{p}} \leq 300 \mu \text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{\text{amb}} = 25 ^{\circ}\text{C} \\ \\ \text{I}_{\text{F}} = 50 \text{ mA; } t_{\text{p}} \leq 300 \mu \text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{\text{amb}} = 25 ^{\circ}\text{C} \\ \\ \text{I}_{\text{F}} = 150 \text{ mA; } t_{\text{p}} \leq 300 \mu \text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{\text{amb}} = 25 ^{\circ}\text{C} \\ \\ \text{V}_{\text{R}} = 75 \text{ V; pulsed; } T_{\text{amb}} = 25 ^{\circ}\text{C} \\ \\ \text{V}_{\text{R}} = 75 \text{ V; pulsed; } T_{\text{amb}} = 25 ^{\circ}\text{C} \\ \\ \text{V}_{\text{R}} = 75 \text{ V; pulsed; } T_{\text{amb}} = 25 ^{\circ}\text{C} \\ \\ \text{V}_{\text{R}} = 0 \text{ V; } f = 1 \text{ MHz; } T_{\text{amb}} = 25 ^{\circ}\text{C} \\ \\ \text{reverse recovery time} \\ \\ \text{I}_{\text{F}} = 10 \text{ mA; } I_{\text{R}} = 10 \text{ mA; } I_{\text{R}(\text{meas})} = 1 \text{ mA; } \\ \end{array}$		$ \begin{array}{llllllllllllllllllllllllllllllllllll$	$ \begin{array}{c} \text{forward voltage} & \text{I}_{\text{F}} = 1 \text{ mA; } t_{\text{p}} \leq 300 \mu\text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{\text{amb}} = 25 \text{ °C} \\ \\ \text{I}_{\text{F}} = 10 \text{ mA; } t_{\text{p}} \leq 300 \mu\text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{\text{amb}} = 25 \text{ °C} \\ \\ \text{I}_{\text{F}} = 50 \text{ mA; } t_{\text{p}} \leq 300 \mu\text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{\text{amb}} = 25 \text{ °C} \\ \\ \text{I}_{\text{F}} = 150 \text{ mA; } t_{\text{p}} \leq 300 \mu\text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{\text{amb}} = 25 \text{ °C} \\ \\ \text{reverse current} & V_{\text{R}} = 75 \text{ V; pulsed; } T_{\text{amb}} = 25 \text{ °C} \\ \\ \text{V}_{\text{R}} = 75 \text{ V; pulsed; } T_{\text{amb}} = 25 \text{ °C} \\ \\ \text{V}_{\text{R}} = 75 \text{ V; pulsed; } T_{\text{amb}} = 25 \text{ °C} \\ \\ \text{reverse recovery time} & I_{\text{F}} = 10 \text{ mA; } I_{\text{R}(\text{meas})} = 1 \text{ mA; } \\ \\ \text{-} & - \\ \end{array} $	$ \begin{array}{c} \text{forward voltage} & \text{I}_{F} = 1 \text{ mA; } t_{p} \leq 300 \mu \text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{amb} = 25 \text{ °C} \\ \\ \text{I}_{F} = 10 \text{ mA; } t_{p} \leq 300 \mu \text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{amb} = 25 \text{ °C} \\ \\ \text{I}_{F} = 50 \text{ mA; } t_{p} \leq 300 \mu \text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{amb} = 25 \text{ °C} \\ \\ \text{I}_{F} = 150 \text{ mA; } t_{p} \leq 300 \mu \text{s; } \delta \leq 0.02; \\ \text{pulsed; } T_{amb} = 25 \text{ °C} \\ \\ \text{reverse current} \\ \\ \text{V}_{R} = 75 \text{ V; pulsed; } T_{amb} = 25 \text{ °C} \\ \\ \text{V}_{R} = 75 \text{ V; pulsed; } T_{amb} = 150 \text{ °C} \\ \\ \text{V}_{R} = 75 \text{ V; pulsed; } T_{amb} = 25 \text{ °C} \\ \\ \text{V}_{R} = 75 \text{ V; pulsed; } T_{amb} = 25 \text{ °C} \\ \\ \text{I}_{F} = 10 \text{ mA; } T_{amb} = 25 \text{ °C} \\ \\ Remptive of the policy o$

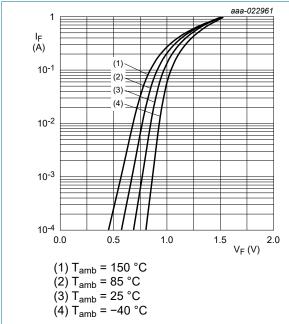
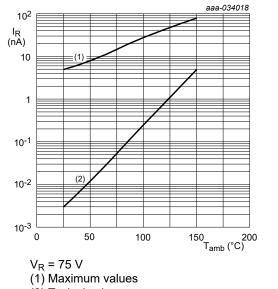


Fig. 3. Forward current as a function of forward voltage; typical values



(2) Typical values

Fig. 4. Reverse current as a function of ambient temperature

Low-leakage diode

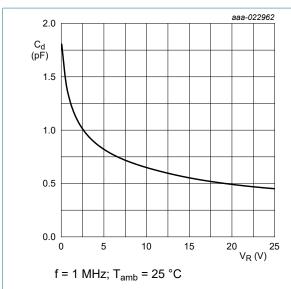


Fig. 5. Diode capacitance as a function of reverse voltage; typical values

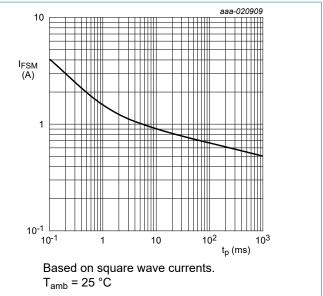
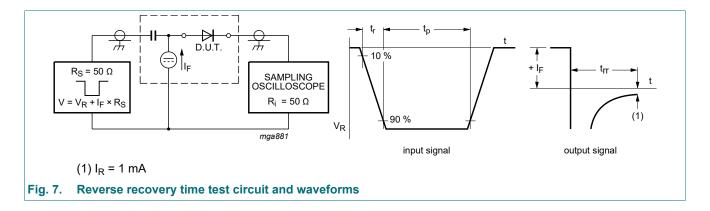


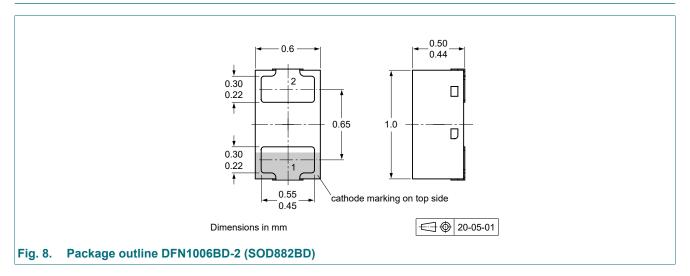
Fig. 6. Non-repetitive forward current as a function of pulse duration; maximum values

Low-leakage diode

11. Test information

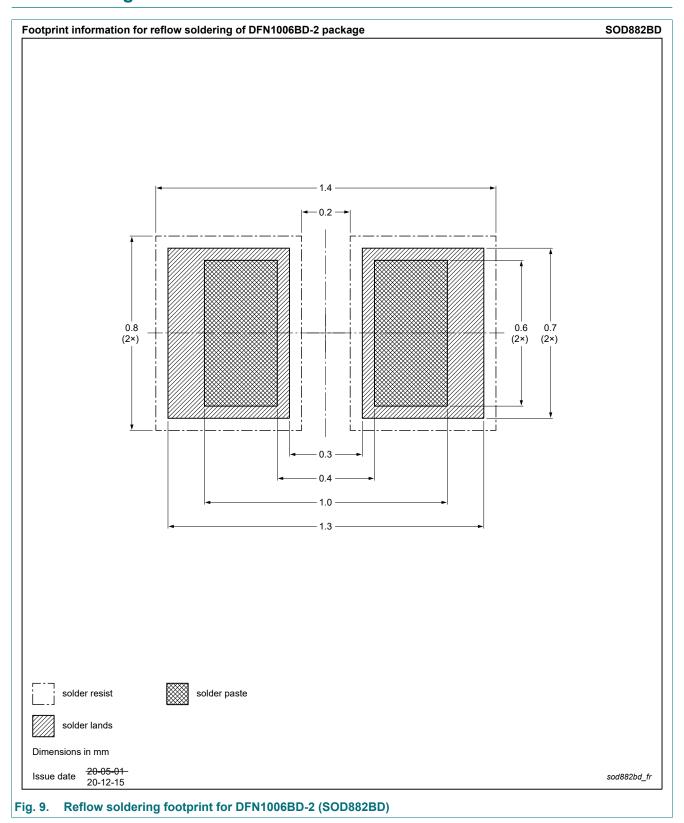


12. Package outline



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13. Soldering



Low-leakage diode

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS116LS v.1	20220103	Product data sheet	-	-

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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